

| PCN Number: | 20120423000 | | PCN Date: | 05/03/2012 | | | | | | | |
|---|---|--------------------------|---------------------------|--------------------------|--------------------------|-----------------|--------------------|------------------|----------------|---|---|
| Title: | End of Life notification for RI-TH1-CB1A-00 | | | | | | | | | | |
| Customer Contact: | PCN Manager | Phone: | +1(214)480-6037 | Dept: | Quality Services | | | | | | |
| Last date to order: | 05/03/2013 | | Last date to ship: | 11/03/2013 | | | | | | | |
| Change Type: | End of Life | | | | | | | | | | |
| <input type="checkbox"/> | Assembly Site | <input type="checkbox"/> | Assembly Process | <input type="checkbox"/> | Assembly Materials | | | | | | |
| <input type="checkbox"/> | Design | <input type="checkbox"/> | Electrical Specification | <input type="checkbox"/> | Mechanical Specification | | | | | | |
| <input type="checkbox"/> | Test Site | <input type="checkbox"/> | Packing/Shipping/Labeling | <input type="checkbox"/> | Test Process | | | | | | |
| <input type="checkbox"/> | Wafer Bump Site | <input type="checkbox"/> | Wafer Bump Material | <input type="checkbox"/> | Wafer Bump Process | | | | | | |
| <input type="checkbox"/> | Wafer Fab Site | <input type="checkbox"/> | Wafer Fab Materials | <input type="checkbox"/> | Wafer Fab Process | | | | | | |
| Product Withdrawal/Discontinuance Notification Details | | | | | | | | | | | |
| Description of Withdrawal/Discontinuance: | | | | | | | | | | | |
| RI-TH1-CB1A-00 is reaching end of life | | | | | | | | | | | |
| Reason for Withdrawal/Discontinuance: | | | | | | | | | | | |
| Texas Instruments Incorporated (TI), Semiconductor Group continually monitors sales and billings activities as well as the availability of newer product versions of older parts. The business activity level and the availability of a newer product version for the products listed below warrant the discontinuance of these products by TI. | | | | | | | | | | | |
| Product Affected: | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th>Affected Device</th> <th>Replacement Device</th> <th>Replacement Note</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">RI-TH1-CB1A-00</td> <td style="text-align: center;">Please contact Cardag Deutschland GmbH</td> <td style="text-align: center;">S</td> </tr> </tbody> </table> | | | | | | Affected Device | Replacement Device | Replacement Note | RI-TH1-CB1A-00 | Please contact Cardag Deutschland GmbH | S |
| Affected Device | Replacement Device | Replacement Note | | | | | | | | | |
| RI-TH1-CB1A-00 | Please contact Cardag Deutschland GmbH | S | | | | | | | | | |
| Replacement Notes: | | | | | | | | | | | |
| F = Similar functionality but not equivalent. | | | | | | | | | | | |
| P = Same functionality but not pin-for-pin equivalent and may not be parametrically equivalent. | | | | | | | | | | | |
| Q = Same functionality and PIN-OUT as the compared device but is NOT an exact equivalent. | | | | | | | | | | | |
| S = EXACT equivalent in functionality and parametrically to the compared device. | | | | | | | | | | | |

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

| Location | E-Mail |
|--------------|--|
| USA | PCNAmericasContact@list.ti.com |
| Europe | PCNEuropeContact@list.ti.com |
| Asia Pacific | PCNAsiaContact@list.ti.com |
| Japan | PCNJapanContact@list.ti.com |